CMOS Digital Integrated Circuits Silicon Monolithic

TC74VHCV240FK,TC74VHCV244FK

1. Functional Description

・ Octal Schmitt Bus Buffer

TC74VHCV240FK: Inverted, 3-State Outputs

TC74VHCV244FK: Non-Inverted, 3-State Outputs

2. General

The TC74VHCV240FK, TC74VHCV244FK are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate CMOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The TC74VHCV240FK is an inverting 3-state buffer having two active-low output enables. The TC74VHCV244FK is a non-inverting 3-state buffer, and has two active-low output enables.

Input pin have hysteresis between the positive-going and negative-going thresholds. Thus the TC74VHCV240FK, TC74VHCV244FK are capable of squaring up transitions of slowly changing input signals and provides an improved noise immunity.

Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output (Note) pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, etc.

Note: Output in off-state

3. Features

(1) High speed: t_{pd} = 3.9 ns (typ.) at V_{CC} = 5.0 V

(2) Low power dissipation: I_{CC} = 2.0 μA (max) at T_a = 25 °C

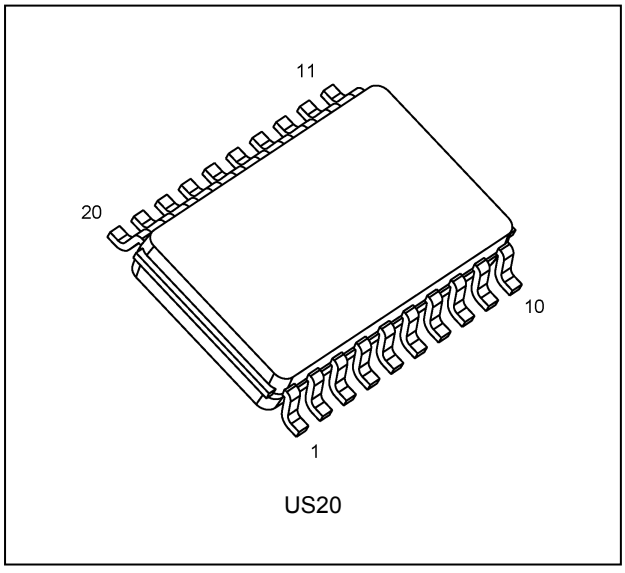
(3) Wide operating voltage range: $V_{CC(opr)}$ = 1.8 V to 5.5 V

(4) Output current: $|I_{OH}|/I_{OL}$ = 16 mA (min) (V_{CC} = 4.5 V)

(5) Power-down protection provided on all inputs.

(6) Pin and function compatible with the 74 series (74AC/HC/AHC/LV etc.) 240 or 244 type.

4. Packaging



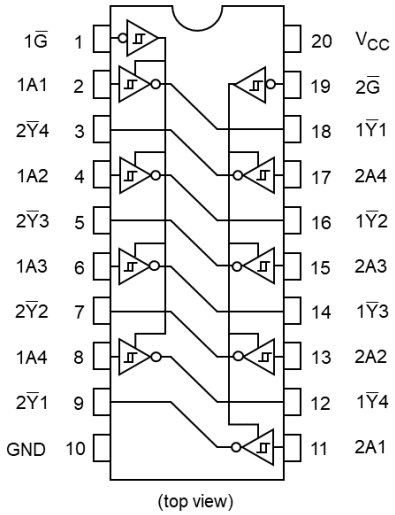
US20

Start of commercial production

2009-12

5. Pin Assignment

TC74VHCV240FK



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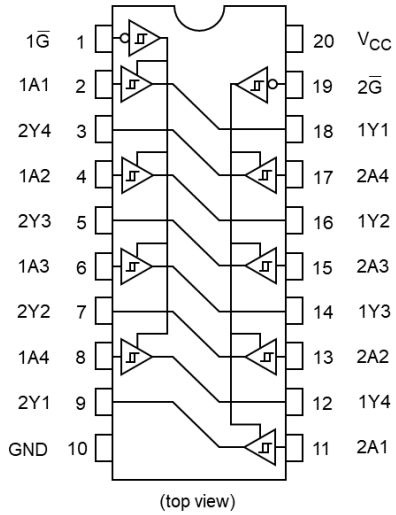
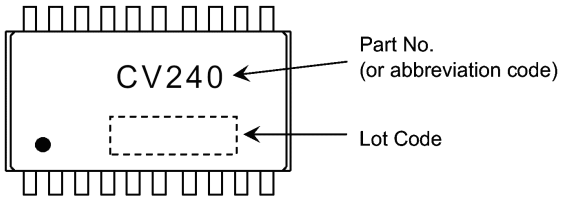


6. Marking

TC74VHCV240FK



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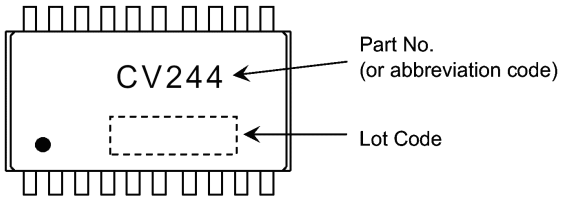


7. Truth Table

Input $\overline{G}$	Input An	Output Yn	Output $\overline{Y}$n
L	L	L	H
L	H	H	L
H	X	Z	Z

X: Don't care
Z: High impedance
Yn: TC74VHCV244FK
$\overline{Y}$n: TC74VHCV240FK

8. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{CC}		-0.5 to 7.0	V
Input voltage	V_{IN}		-0.5 to 7.0	V
Output voltage	V_{OUT}	(Note 1)	-0.5 to 7.0	V
		(Note 2)	-0.5 to V_{CC} + 0.5	
Input diode current	I_{IK}		-50	mA
Output diode current	I_{OK}	(Note 3)	±50	mA
Output current	I_{OUT}		±50	mA
Power dissipation	P_D		180	mW
V_{CC}/ground current	I_{CC}		±100	mA
Storage temperature	T_{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Output in OFF state.

Note 2: High (H) or Low (L) state. I_{OUT} absolute maximum rating must be observed.

Note 3: V_{OUT} < GND, V_{OUT} > V_{CC}

9. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V_{CC}		—	1.8 to 5.5	V
Input voltage	V_{IN}		—	0 to 5.5	V
Output voltage	V_{OUT}	(Note 1)	—	0 to 5.5	V
		(Note 2)	—	0 to V_{CC}	
Operating temperature	T_{opr}		—	-40 to 85	°C
Input rise and fall times	dt/dv		V_{CC} = 3.3 ± 0.3 V	0 to 20	ms/V
			V_{CC} = 5.0 ± 0.5 V	0 to 1	

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

Note 1: Output in OFF state.

Note 2: High (H) or Low (L) state.

10. Electrical Characteristics

10.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Typ.	Max	Unit
Positive threshold voltage	V_P	—		1.8	—	—	1.65	V
				2.3	—	—	1.85	
				3.0	—	—	2.20	
				4.5	—	—	3.15	
				5.5	—	—	3.85	
Negative threshold voltage	V_N	—		1.8	0.15	—	—	V
				2.3	0.45	—	—	
				3.0	0.90	—	—	
				4.5	1.35	—	—	
				5.5	1.65	—	—	
Hysteresis voltage	V_H	—		1.8	0.15	—	1.05	V
				2.3	0.20	—	1.10	
				3.0	0.30	—	1.20	
				4.5	0.40	—	1.40	
				5.5	0.50	—	1.60	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = -50 μA	1.8	1.7	1.8	—	V
				3.0	2.9	3.0	—	
				4.5	4.4	4.5	—	
			I_{OH} = -8 mA	3.0	2.58	—	—	
			I_{OH} = -16 mA	4.5	3.94	—	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 50 μA	1.8	—	0.0	0.1	V
				3.0	—	0.0	0.1	
				4.5	—	0.0	0.1	
			I_{OL} = 8 mA	3.0	—	—	0.36	
			I_{OL} = 16 mA	4.5	—	—	0.44	
3-state output OFF-state leakage current	I_{OZ}	V_{IN} = V_{IH} or V_{IL} V_{OUT} = 0 to 5.5 V		1.8 to 5.5	—	—	±0.5	μA
Power-OFF leakage current	I_{OFF}	V_{IN}/V_{OUT} = 5.5 V		0	—	—	0.5	μA
Input leakage current	I_{IN}	V_{IN} = 5.5 V or GND		0 to 5.5	—	—	±0.1	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		5.5	—	—	2.0	μA

10.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
Positive threshold voltage	V_P	—		1.8	—	1.65	V
				2.3	—	1.85	
				3.0	—	2.20	
				4.5	—	3.15	
				5.5	—	3.85	
Negative threshold voltage	V_N	—		1.8	0.15	—	V
				2.3	0.45	—	
				3.0	0.90	—	
				4.5	1.35	—	
				5.5	1.65	—	
Hysteresis voltage	V_H	—		1.8	0.15	1.05	V
				2.3	0.20	1.10	
				3.0	0.30	1.20	
				4.5	0.40	1.40	
				5.5	0.50	1.60	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = -50 μA	1.8	1.7	—	V
				3.0	2.9	—	
				4.5	4.4	—	
			I_{OH} = -8 mA	3.0	2.48	—	
			I_{OH} = -16 mA	4.5	3.80	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 50 μA	1.8	—	0.1	V
				3.0	—	0.1	
				4.5	—	0.1	
			I_{OL} = 8 mA	3.0	—	0.44	
			I_{OL} = 16 mA	4.5	—	0.55	
3-state output OFF-state leakage current	I_{OZ}	V_{IN} = V_{IH} or V_{IL} V_{OUT} = 0 to 5.5 V		1.8 to 5.5	—	±5.0	μA
Power-OFF leakage current	I_{OFF}	V_{IN}/V_{OUT} = 5.5 V		0	—	5.0	μA
Input leakage current	I_{IN}	V_{IN} = 5.5 V or GND		0 to 5.5	—	±1.0	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		5.5	—	20.0	μA

10.3. AC Characteristics (Unless otherwise specified, T_a = 25 °C, Input: $t_r = t_f$ = 3 ns)

Characteristics	Part Number	Symbol	Note	Test Condition	V_{CC} (V)	C_L (pF)	Min	Typ.	Max	Unit
Propagation delay time	TC74VHCV240FK	t_{PLH},t_{PHL}		—	2.5 ± 0.2	15	—	6.4	11.6	ns
						50	—	9.2	14.4	
					3.3 ± 0.3	15	—	5.0	7.5	
						50	—	7.0	11.0	
					5.0 ± 0.5	15	—	3.9	5.5	
						50	—	5.4	7.5	
Propagation delay time	TC74VHCV244FK	t_{PLH},t_{PHL}		—	2.5 ± 0.2	15	—	6.7	12.5	ns
						50	—	9.5	15.3	
					3.3 ± 0.3	15	—	5.0	8.4	
						50	—	7.2	11.9	
					5.0 ± 0.5	15	—	3.8	5.5	
						50	—	5.4	7.5	
3-state output enable time		t_{PZL},t_{PZH}		R_L = 1 kΩ	2.5 ± 0.2	15	—	7.8	14.6	ns
						50	—	11.1	17.8	
					3.3 ± 0.3	15	—	5.7	10.6	
						50	—	8.4	14.1	
					5.0 ± 0.5	15	—	4.1	7.3	
						50	—	6.2	9.3	
3-state output disable time		t_{PLZ},t_{PHZ}		R_L = 1 kΩ	2.5 ± 0.2	50	—	14.3	19.2	ns
					3.3 ± 0.3	50	—	10.9	14.0	
					5.0 ± 0.5	50	—	8.7	9.2	
Output skew		t_{osLH},t_{osHL}	(Note 1)	—	2.5 ± 0.2	50	—	—	2.0	ns
					3.3 ± 0.3	50	—	—	1.5	
					5.0 ± 0.5	50	—	—	1.0	
Input capacitance		C_{IN}		—			—	4	10	pF
Output capacitance		C_{OUT}		—			—	6	—	pF
Power dissipation capacitance	TC74VHCV240FK	C_{PD}	(Note 2)	—			—	20	—	pF
	TC74VHCV244FK	C_{PD}	(Note 2)	—			—	21	—	pF

Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLH}m - t_{PLH}n|$, $t_{osHL} = |t_{PHL}m - t_{PHL}n|$)

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$ (per bit)

10.4. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: $t_r = t_f$ = 3 ns)

Characteristics	Part Number	Symbol	Note	Test Condition	V_{CC} (V)	C_L (pF)	Min	Max	Unit
Propagation delay time	TC74VHCV240FK	t_{PLH},t_{PHL}		—	2.5 ± 0.2	15	1.0	14.0	ns
						50	1.0	17.0	
					3.3 ± 0.3	15	1.0	9.0	
						50	1.0	12.5	
					5.0 ± 0.5	15	1.0	6.5	
						50	1.0	8.5	
Propagation delay time	TC74VHCV244FK	t_{PLH},t_{PHL}		—	2.5 ± 0.2	15	1.0	15.0	ns
						50	1.0	18.0	
					3.3 ± 0.3	15	1.0	10.0	
						50	1.0	13.5	
					5.0 ± 0.5	15	1.0	6.5	
						50	1.0	8.5	
3-state output enable time		t_{PZL},t_{PZH}		R_L = 1 kΩ	2.5 ± 0.2	15	1.0	17.0	ns
						50	1.0	21.0	
					3.3 ± 0.3	15	1.0	12.5	
						50	1.0	16.0	
					5.0 ± 0.5	15	1.0	8.5	
						50	1.0	10.5	
3-state output disable time		t_{PLZ},t_{PHZ}		R_L = 1 kΩ	2.5 ± 0.2	50	1.0	21.0	ns
					3.3 ± 0.3	50	1.0	16.0	
					5.0 ± 0.5	50	1.0	10.5	
Output skew		t_{osLH},t_{osHL}	(Note 1)	—	2.5 ± 0.2	50	—	2.0	ns
					3.3 ± 0.3	50	—	1.5	
					5.0 ± 0.5	50	—	1.0	
Input capacitance		C_{IN}		—			—	10	pF

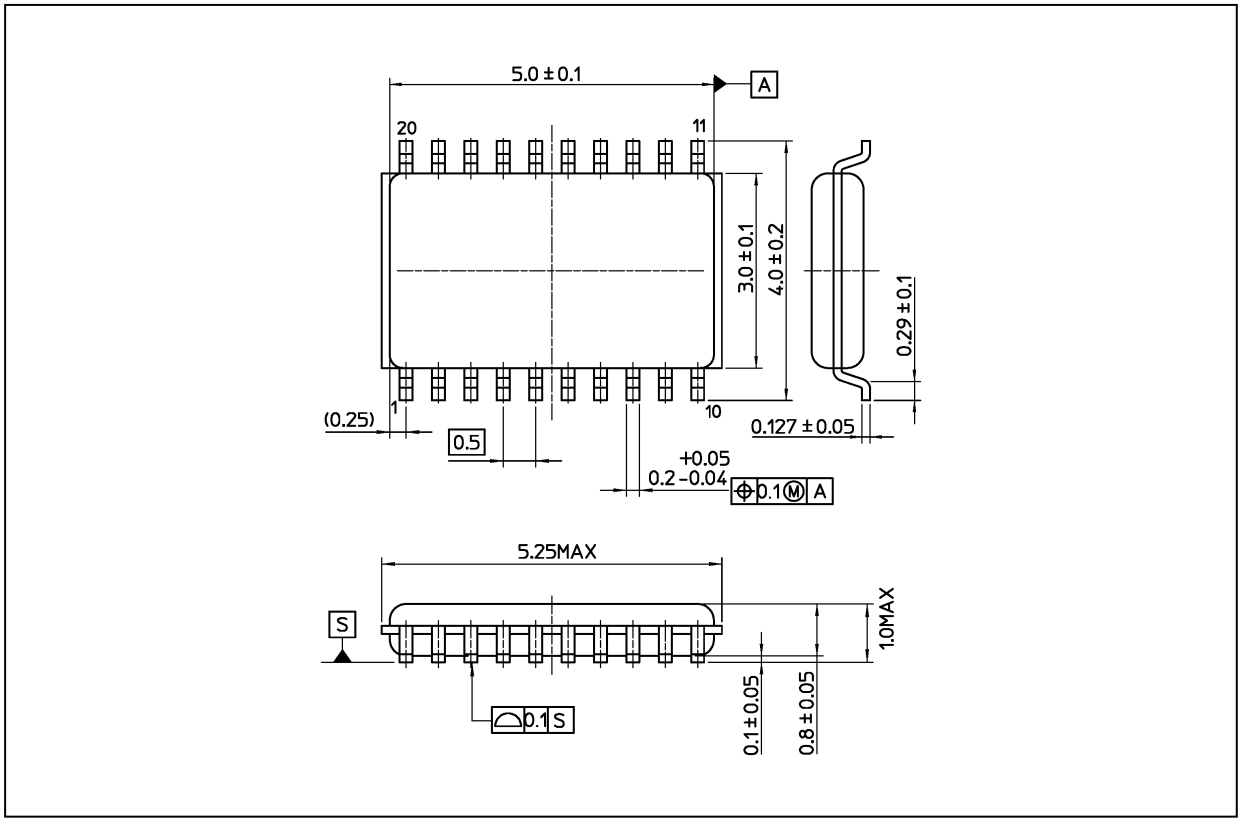
Note 1: Parameter guaranteed by design. (t_{osLH} = $|t_{PLH}m-t_{PLH}n|$, t_{osHL} = $|t_{PHL}m-t_{PHL}n|$)

10.5. Noise Characteristics (Unless otherwise specified, T_a = 25 °C, Input: $t_r = t_f$ = 3 ns)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Typ.	Limit	Unit
Quiet output maximum dynamic V_{OL}	V_{OLP}	C_L = 50 pF	3.3	0.45	—	V
			5.0	0.9	—	
Quiet output minimum dynamic V_{OL}	V_{OLV}	C_L = 50 pF	3.3	-0.1	—	V
			5.0	-0.3	—	
Minimum high-level dynamic input voltage	V_{IHD}	C_L = 50 pF	5.0	—	3.5	V
Maximum low-level dynamic input voltage	V_{ILD}	C_L = 50 pF	5.0	—	1.5	V

Package Dimensions

Unit: mm



Weight: 0.03 g (typ.)

Package Name(s)
Nickname: US20

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